



Huawei Hong Kong Research Center

Huawei Hong Kong Research Center was established in 2018, with focus on CPU, Basic Software, AI related research and development, from algorithm, software to chip set development. We are looking for high caliber Engineers and Researchers at all levels to join our new team.

模拟芯片设计暑期实习生

【工作职责】

- 理解客户需求，承接团队的芯片方案任务
- 负责模拟芯片关键 IP（如 AFE、PMU、ADC 等）的电路设计，验证，优化等工作，确保电路设计满足规格要求，以芯片最后交付为目标

【任职要求】

业务技能要求：

- 电子专业本科、硕士或博士
- 扎实的模拟电路理论基础，熟悉各类基本单元电路设计
- 有 ADC/PMU 相关设计经验优先
- 有成功投片经验与芯片量产经验优先

专业知识要求：

- 扎实的电路设计基础，具有射频芯片电路相关知识，EM 仿真能力，熟悉模拟/混合信号开发流程，掌握相关设计工具
- 熟练掌握模拟电路（AFE、PMU、ADC 等）专业知识

Analog Chip Design - Summer Intern

【Job Responsibilities】

- Understand customer's needs to deliver IC solution
- Responsible for key analog IP (e.g. AFE, PMU and ADC etc.) circuit design, verification and optimization etc., and targeting to meet specifications and the final delivery of the IC

【Job Requirements】

Skills requirements:

- Bachelor, Master, or Doctorate in electronics
- Solid theoretical foundation of analog circuits, and familiar with circuit design of various basic building blocks
- ADC/PMU related design experience is preferred
- Successful IC tape-out and mass production experience are preferred

Knowledge requirements:

- Solid foundation on circuit design with RFIC knowledge and EM simulation capability, familiar with analog mixed-signal IC development process, and mastering relevant CAD tools
- Proficient professional knowledge in analog circuits (e.g. AFE, PMU and ADC etc.)

For interested parties, please send your full resume and salary expectation to lin.haoyao@huawei.com. Applicants who are not invited for interview within 6 weeks from the closing date may assume their application unsuccessful.